
TECHNICAL SPECIFICATIONS

IDE 20 SERIES FLASH DRIVE 2.5"

| | |
|-----------------------------|-------------|
| EDI7P008 IDE 2011C25 | 8MB |
| EDI7P016 IDE 2011C25 | 16MB |
| EDI7P032 IDE 2011C25 | 32MB |
| EDI7P040 IDE 2011C25 | 40MB |
| EDI7P048 IDE 2011C25 | 48MB |

Description

Models 7P008IDE20, 7P016IDE20, 7P032IDE20, 7P040IDE20, 7P048IDE20 are Flash IDE drives. They are non-volatile mass memory storage systems, for mobile computing and industrial applications. Flash drives fit into standard disk drive bays and use the industry standard IDE interface. They are light-weight, low profile devices.

System Features

- MS DOS compatible
- Low power
- Power down mode
- 3V or 5V supply
- High reliability based on wear leveling system
- Automatic error detection and correction
- Block size 512 bytes

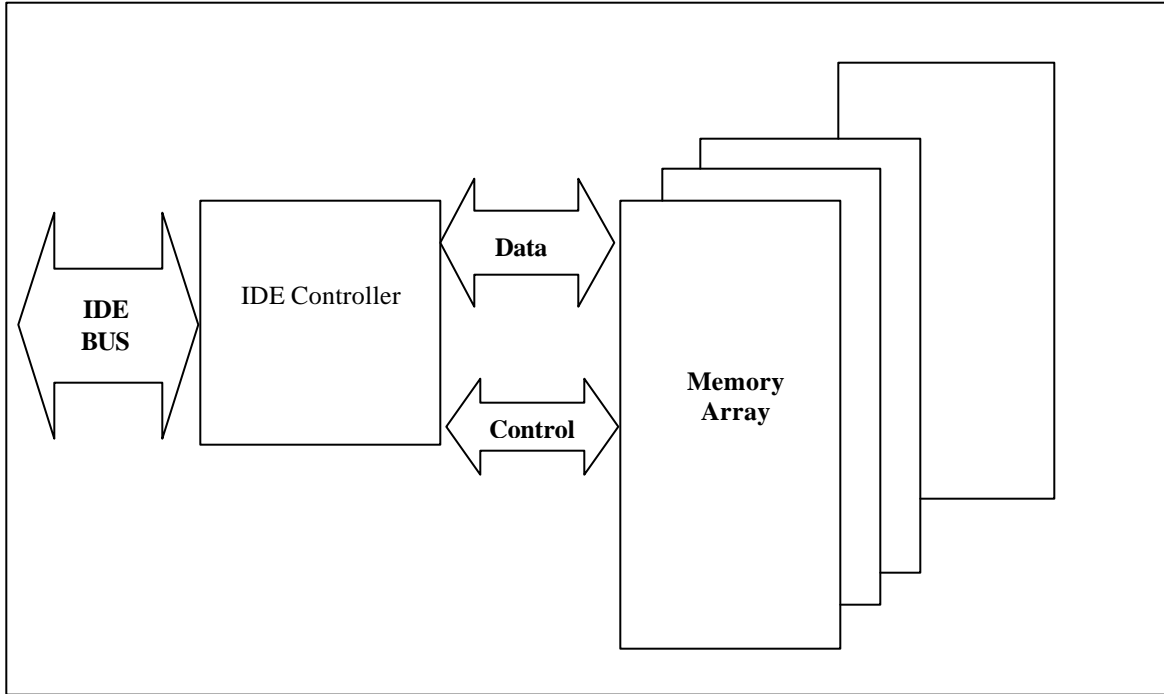


Figure 1: Card Block Diagram

Interface Description

The IDE20 flash drive complies with the ATA-3 standard.

Supported modes:

- PIO mode 1, 2, 3 and 4

Related document: **American National Standard X3T9.2 AT Attachment Interface document**

Drive Line Up

| Drive type | Drive density | Capacity (3) | Total sectors/ card (2) | Sectors / track | Number of heads | Number of cylinders |
|-----------------|---------------|-----------------|----------------------------|-----------------|-----------------|---------------------|
| 7P008ATA2003C25 | 8MB | 8,060,928 Byte | 15,744 | 32 | 2 | 246 |
| 7P016ATA2003C25 | 16MB | 16,121,856 Byte | 31,488 | 32 | 4 | 246 |
| 7P032ATA2003C25 | 32MB | 32,243,712 Byte | 62,976 | 32 | 4 | 492 |
| 7P040ATA2003C25 | 40MB | 40,370,176 Byte | 78,848 | 32 | 4 | 616 |
| 7P048ATA2003C25 | 48MB | 48,365,568 Byte | 94,464 | 32 | 4 | 738 |

- Notes:
1. Total tracks = number of heads × number of cylinders.
 2. Total sectors/card = sectors/track × number of heads × number of the cylinders.
 3. It is the logical address capacity including the area which is used for file system.

Card Pin Assignment

| True IDE mode | | | True IDE mode | | |
|---------------|-------------|---------|---------------|-------------|---------|
| Pin NO. | Signal name | I/O | Pin NO. | Signal name | I/O |
| 1 | -RESET | I | 2 | GND | Ground |
| 3 | D7 | I/O | 4 | D8 | I/O |
| 5 | D6 | I/O | 6 | D9 | I/O |
| 7 | D5 | I/O | 8 | D10 | I/O |
| 9 | D4 | I/O | 10 | D11 | I/O |
| 11 | D3 | I/O | 12 | D12 | I/O |
| 13 | D2 | I/O | 14 | D13 | I/O |
| 15 | D1 | I/O | 16 | D14 | I/O |
| 17 | D0 | I/O | 18 | D15 | I/O |
| 19 | GND | Ground | 20 | key | removed |
| 21 | Reserved | NC | 22 | GND | Ground |
| 23 | -IOW | I | 24 | GND | Ground |
| 25 | -IOR | I | 26 | GND | Ground |
| 27 | WAIT | O | 28 | CSEL | I |
| 29 | reserved | NC | 30 | GND | Ground |
| 31 | IRQ | O | 32 | -IOCS16 | O |
| 33 | A1 | I | 34 | -PDIAG | I/O |
| 35 | A0 | I | 36 | A2 | I |
| 37 | -CE1 | I | 38 | -CE2 | I |
| 39 | -DASP | I/O | 40 | GND | Ground |
| 41 | Vcc | power | 42 | Vcc | power |
| 43 | GND | Ground | 44 | reserved | NC |
| 45 | key | removed | 46 | key | removed |
| 47 | GND | Ground | 48 | SLAVE | I |
| 49 | SLAVE | I | 50 | GND | Ground |

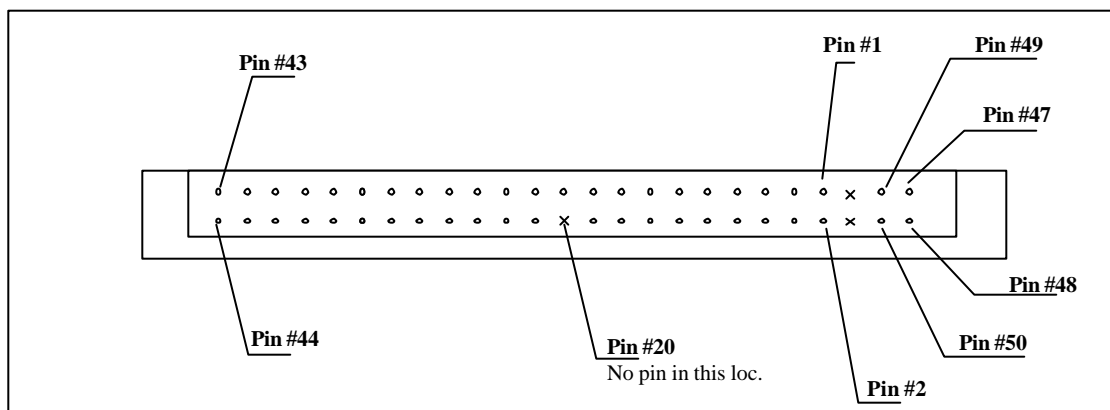


Figure 2: Pin Configuration

Drive Pin Explanation

Address bus (A0 to A2: input): In True IDE Mode only A [2 : 0] are used for selecting the one of eight registers in the Task File.

Data bus (D0 to D15: input/output): Data bus is D0 to D15. D0 is the LSB of the Even Byte of the Word. D8 is the LSB of the Odd Byte of the Word.

Card enable (-CE1, -CE2: input): In True IDE Mode -CE2 is used for select the Alternate Status Register and the Device Control Register while -CE1 is the chip select for the other task file registers.

I/O read (-IORD: input): -IORD is used for control of read data in the Task File area.

I/O write (-IOWR: input): -IOWR is used for control of data write in the Task File area.

Interrupt request (IRQ: output): In True IDE Mode the signal is the active high Interrupt Request to the host.

-IOIS16: (output) In True IDE Mode this output signal is asserted low when this device is expecting a word data transfer cycle.

Disk active/slave present (-DASP: input/output): In True IDE Mode -DASP is the Disk Active/Slave Present signal in the Master/Slave handshake protocol.

Reset (-RESET: input): By assertion of the RESET signal, all registers of this card are cleared and the RDY/-BSY signal turns to high level. In True IDE Mode -RESET is the active low hardware reset from the host.

Wait (-WAIT, IORDY: output): In True IDE Mode this output signal may be used as IORDY. As for this controller, this output is high impedance state constantly.

Pass diagnostic (-PDIAG: input/output): In True IDE Mode, -PDIAG is the Pass Diagnostic signal in the Master/Slave handshake protocol.

Card select (-CSEL: input): This internally pulled up signal is used to configure this device as a Master or a Slave when configured in the True IDE Mode. When this pin is grounded, this device is configured as a Master. When the pin is open, this device is configured as a Slave.

Master/Slave configuration: If the flash drive is being installed as a second drive (or Slave), pin 48 or pin 49 must be grounded. Pins 48 and 49 are inputs with pull up resistors and they are shorted internally. If both pins are open, the flash drive is configured as the Master drive or as the only one drive in the system.

NOTE: Detailed description of flash drive functionality, including timing can be found in the technical specification for PCMCIA card: **ATA20 series**.

Physical Outline

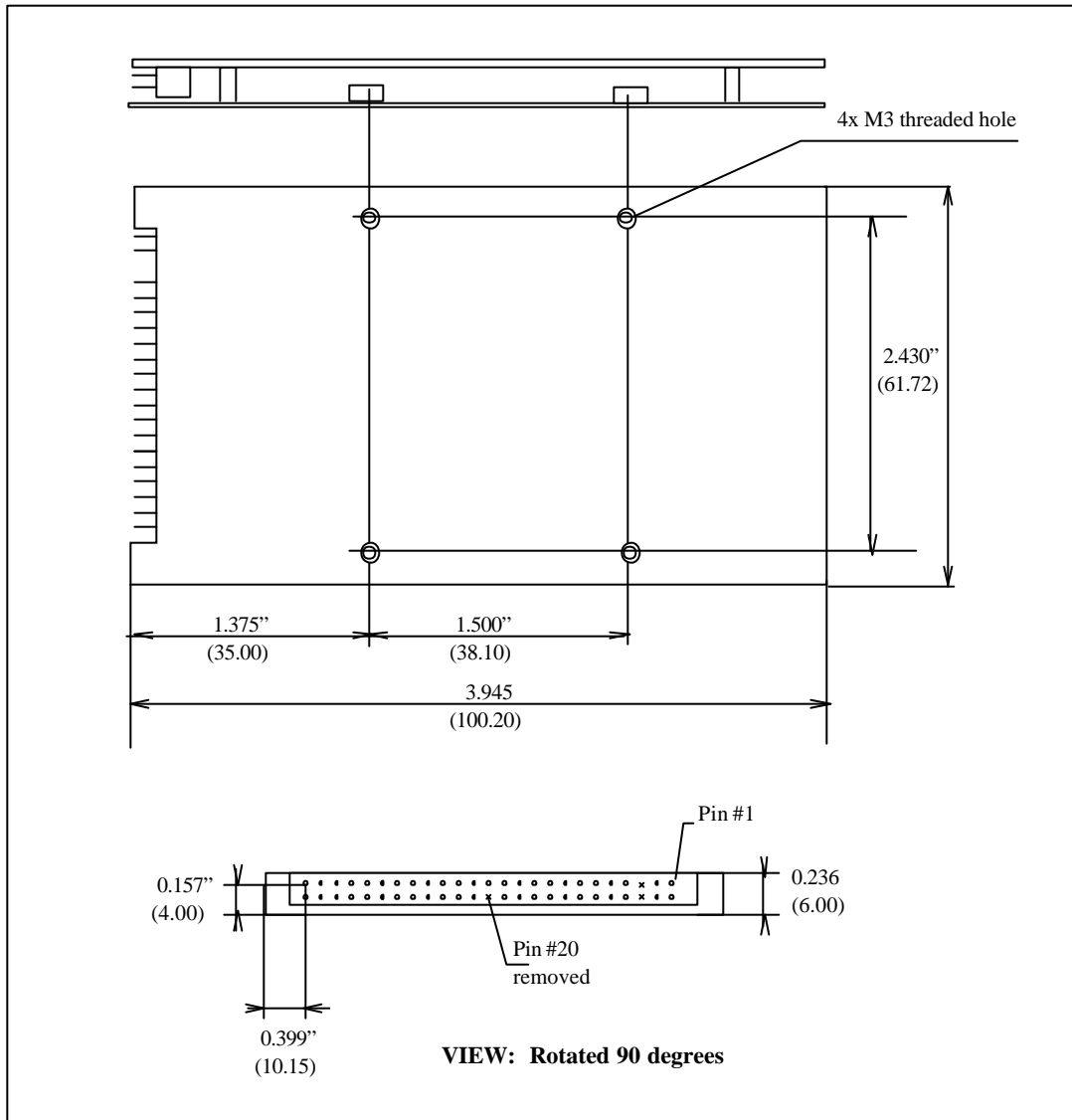


Figure 3: Physical Dimensions - Version 1

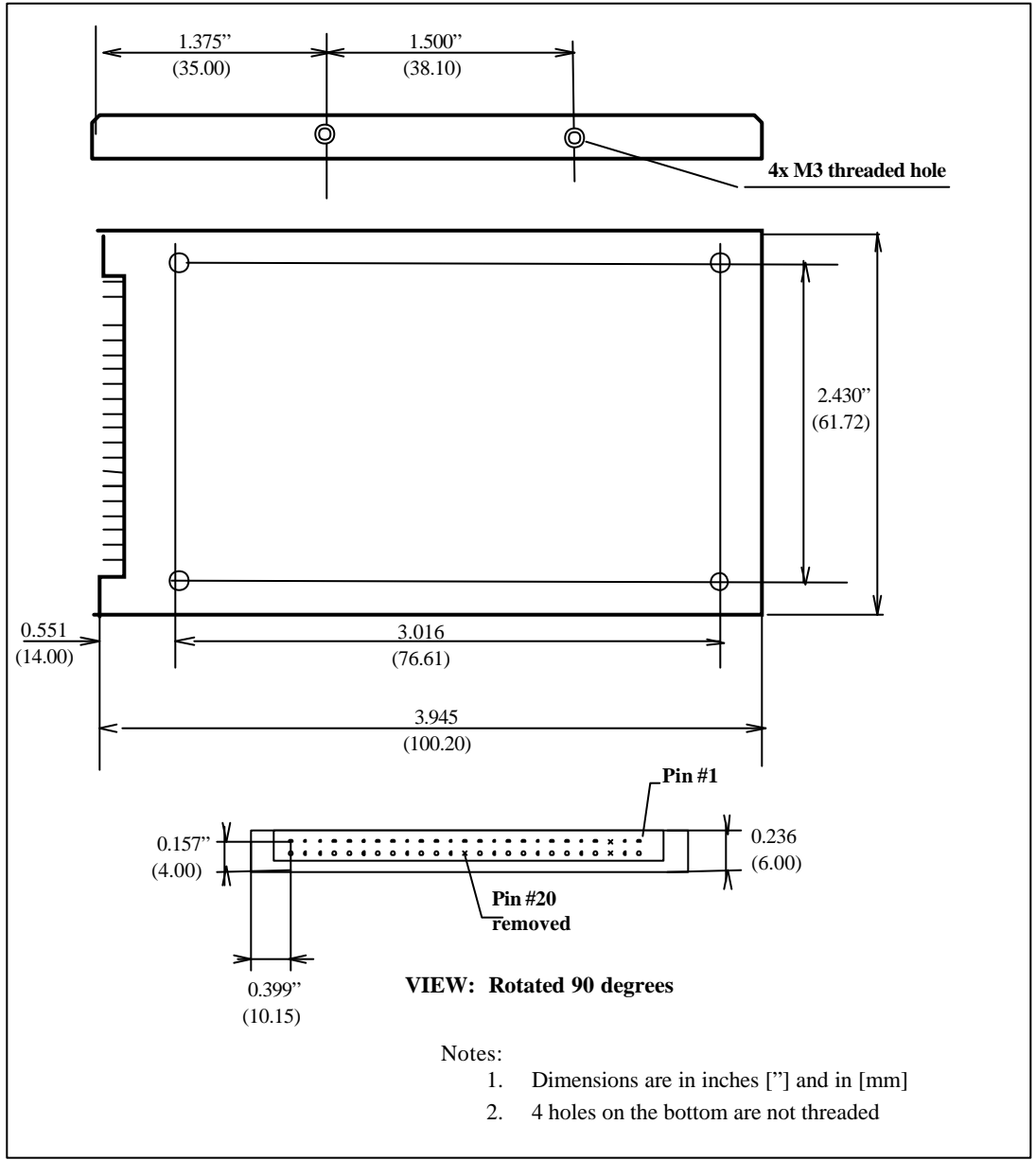


Figure 4: Physical Dimensions - Version 2

Ordering Information

EDI7P XXX IDE YY SS T ZZ

Where

XXX (unformatted capacity):

| | |
|--------------------------------------|--------------|
| 008 | 8MB |
| 016 | 16MB |
| 032 | 32MB |
| 040 | 40MB |
| 048 | 48MB |
| in future higher capacity available: | |
| 064 | 64MB |
| 080 | 80MB |
| 096 | 96MB |
| 160 | 160MB |
| 192 | 192MB |
| 256 | 256MB |
| 512 | 512MB |
| 1G0 | 1024MB (1GB) |

YY: 20 Standard, 3V/5V: (Controller type = HN)

SS: 11 2.5" IDE format: Version 1
12 2.5" IDE format: Version 2

T: C Commercial Temperature Range
I Industrial Temperature Range

ZZ: 25 250ns



Revision Record

| Rev. | Date | Contents of Modification | Drawn by |
|------|--------------|---|----------|
| 0 | Feb 7, 1999 | Initial issue | W. Brys |
| 1 | May 27, 1999 | Company/Logo change | W. Brys |
| 2 | May 18, 2000 | Added Figure for Dimensions of Version 2 Added Version 2 housing to Ordering Information | W. Brys |

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